STRUCTURAL AND ELECTRICAL PROPERTIES OF SILICON NITRIDE CERAMIC

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Abstract: The effects of structural properties on the d.c. and a.c. electrical properties of different weight gain reaction bonded silicon nitride (RBSN) have been studied in this work. The degree of nitridation is assessed by the 'weight gain' of the ceramic, the percentage by which the weight is increased in the nitriding reaction. From X-ray diffraction (XRD) patterns, it is observed that a higher degree of nitradation sample has strong α -silicon nitride peaks. Intensity of α -silicon nitride peaks decreases with decreases weight gain. The higher degrees of nitridation, the samples have less significant Si peak. XRD patterns were recorded to calculate the lattice parameters of RBSN. The lattice parameters for three weight gain RBSN samples are found to be a = b =7.7727 Å, c = 5.6565 Å (26% weight gain), a = b =7.6272 Å, c = 5.6374 Å (42% weight gain) and a=b=7.6158 Å, c=5.7732 Å (58.27% weight gain)and are in good agreement with the reported values from XRD patterns. Porosity (%) and surface morphology was observed by SEM.

Keywords: Silicon nitride ceramic, electrical properties and structural properties.

1. Introduction

Silicon nitride (Si_3N_4) is one of the most promising ceramic materials was developed in the 1960's and 70 s in a search for fully dense, high strength and high toughness materials. As a high temperature engineering ceramic attracted more attention because of its promising thermo mechanical properties such as high temperature mechanical strength, durability, thermal shock resistance chemical corrosion resistance etc. Also Si_3N_4 is a potentially high thermal conductivity material with an intrinsic value of up to $200Wm^{-1}K^{-1}$. Silicon nitride is being considered for a wide variety of structural

application, hot flow-path components for gas turbine engine, turbocharger rotors and diesel engine components. A major application of silicon nitride ceramic aimed in the construction of a gas turbine engine. If the target is realized, fuel saving of up to 40% for a given power output should be possible. In addition, the engine would be lighter and constructed from cheap and readily available materials [1]. Although the ultimate goal of a ceramic has never been achieved, silicon nitride has been used in a number of industrial applications, such as engine components, bearings and cutting tools. Si_3N_4 Can be hot pressed (HPSN) to full density such materials exhibit good low temperature mechanical properties. However, because a hotpressing aid must be used, the high temperature properties may be severally degraded (the severity depends on the type and amount of additive). Furthermore Si_3N_4 can only be hot pressed in simple configuration. While diamond - grinding might be used to form complex components, it cost would be prohibited for most application. Si_3N_4 also can be cold formed and sintered (SSN) to near fully density however, sintering aids must be used in large quantities which can lead to the deterioration of high temperature properties as in the case of hotpressed Si_3N_4 [2-3]. The most commonly used additives are magnesium oxide (MgO) and yttrium oxide (Y2O3), which can be used separately, in combination or with aluminum oxide (Al₂O₃). Interest in RBSN as a hightemperature engineering ceramics was first shown about twenty years ago by Norman Parr of the admiralty Materials laboratory and Popper

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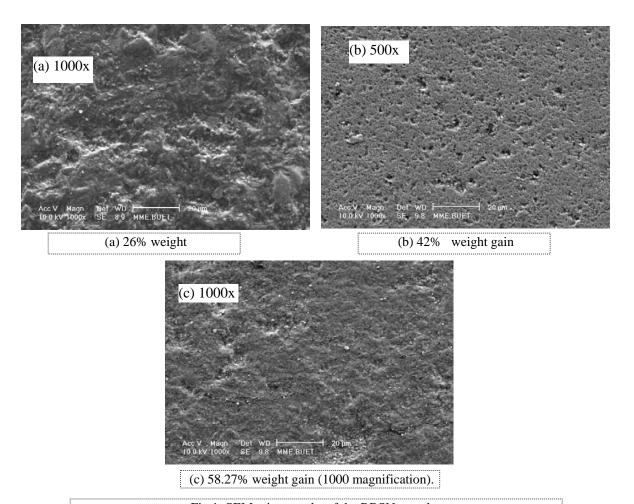


Fig.1: SEM micrographs of the RBSN samples

[4-5] of the British Ceramic Research Association, both in United Kingdom. RBSN produced by reaction bonding of silicon powder compacts is cheaper ompared to sintered Si_3N_4 , because the price of Si powder is much lower than that of Si_3N_4 powder. Reaction bonding processes generally require lower fabrication temperatures than hot pressing and pressure less sintering which is a potential advantage for processing ceramic-matrix composites where high temperatures can damage the reinforcement phase [6-7].

2. Materials and Methods

From the XRD, it is found that the density increases and porosity decreases as weight gain increases. Scanning Electron Microscope (SEM) was used to see surface morphology. The D.C. measurement set up is shown in Fig. 1. For D.C.

electrical measurement of RBSN, electroding, Keithly 614 electrometer, D.C. power supply, specimen chamber, and heating coil are used. A Brief description of these instruments is given below. The Agilent 4192 A Impedance Analyzer (5Hz-13 MHz) was used in the A.C. measurement. This instrument can measure various parameters; resistance (R), Conductivity (G) etc. The following ac electrical parameters will be measured at different frequencies and temperatures: i) ac capacitance (C_p) and ii) ac conductance $(G_{\mathfrak{p}}).$ Then ac electrical conductivity (σ_{ac}) , dielectric constant (\in') and loss tangent ($tan\delta$) will be calculated. These measurements were taken against the frequency value from 5Hz to 13 MHz. The arrangement of A.C.measurement is shown in Fig.8 During the observations for different frequencies of a sample a particular temperature was maintained. The calculations were performed using the

observed values of conductance (G_p) and capacitance (C_p) at different frequencies and temperatures by the following relations for conductivity $\sigma_{ac} = (d/A \ G_p)$, where $G_p =$ conductance, d = thickness of the sample and A = area of the electrode area. For dielectric constant $\in' = C_p \times (d/A \in_o)$, where $C_p =$ capacitance of the sample, $\in_o =$ permittivity of free space .For dielectric loss tangent $\tan \delta = G_p/(2\pi f C_p)$, where f = linear frequency. The Bragg's law is the cornerstone of XRD analysis; it allows us to make accurate quantification of the results of experiments carried out to determine crystal structure. It was formulated in 1912 by W L

Bragg, in order to explain the observed phenomenon that crystals only reflected X-rays at certain angles of incidence. For morphology investigation, the different weight gain RBSN samples are examined with scanning electron microscope Philips XL30 (Nether land). A study on microstructure is done by SEM observation.

3. Results and Discussion3.1 SEM Analysis

SEM micrographs of different RBSN samples are shown in Fig. 1. and Fig. 2. of 100x and 500x magnification respectively.

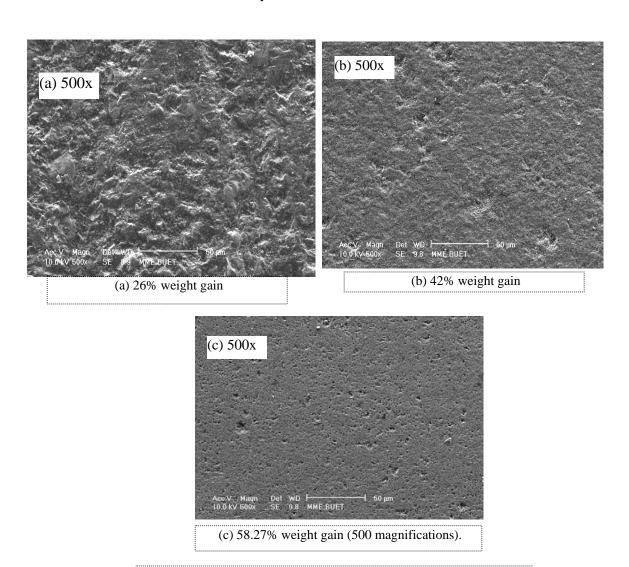


Fig.2: SEM micrographs of the RBSN samples

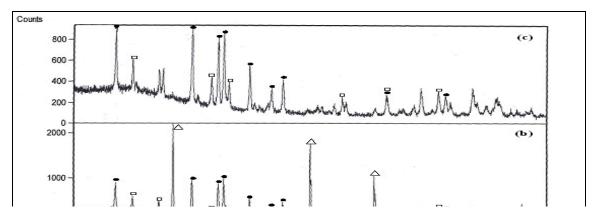


Fig: 3: XRD Patterns of (a) 26% weight gain, (b) 42% weight gain, (c) 58.27% weight gain RBSN

The samples are exhibited a typical development of RBSN with porous microstructure. The micrographs of 26% weight gain sample in Fig. 1.(a) & 2.(a), it is seen that the surface is rough and porous. The developments of large pores are shown in Fig. 1.(a) & 2.(a), for 26% weight gain sample. From SEM micrographs of different weight gain samples, it is observed that the porosity decreases with increasing weight gain and the surface of the samples become smoother. These facts support the observations by SEM.

3.2 XRD Analysis

X-ray diffraction (XRD) patterns of different weight gain RBSN samples are presented in Fig. 3. The XRD pattern of 26% weight gain sample has strong silicon peaks and less significant α and β - silicon nitride peaks. The XRD patterns of 42% weight gain sample has silicon and α and β -silicon nitride peaks. The XRD patterns of 58.27% weight gain sample exhibits β -silicon nitride peaks and strong α - silicon nitride peaks. It could be noticed that there is increase in peak intensity of α - and β -silicon nitride with the

increase of weight gain %. It is observed that the peak intensity of α - silicon nitride phase stronger in 58.27% weight gain sample than those in other samples. A distinct feature of the nitridation of Si is that both α and β phases are always simultaneously formed, that is, the Si₃N₄ product usually consist of both α and β phases. Moulson [4] proposed that major growth of βphase occurs in the liquid phase and to a minor extent, as a result of the reaction of solid silicon and nitrogen and the growth of α -phase occurs by vapor phase reaction. α - and β - Si₃N₄ are polymorphs of Si_3N_4 with α - Si_3N_4 having the slightly higher free energy at the formation temperature. RBSN sample crystallizes in the hexagonal system. From XRD results, lattice parameters were calculated using the formula for hexagonal system. The calculated lattice parameters a, b and c are shown in table-1. Experimental values of lattice parameters are very close to the reported standard values [7] as mentioned below. The volumes of the unit cells of different samples are given in Table 1.

Table 1: Lattice Parameters of Different Weight Gain RBSN Samples

Samples of RBSN	Experimental lattice parameter			Volume of unit cell Å ³
	a (Å)	b (Å)	c(Å)	
Reported standard values for Si ₃ N ₄ [6]	7.7541	7.7541	5.6217	292.73
26% weight gain	7.7727	7.7727	5.6565	341.73
42% weight gain	7.6272	7.6272	5.6374	327.95
58.27% weight gain	7.6158	7.6158	5.7732	334.85

Porosity were calculated from XRD patterns by using the formula, p (%)= $\frac{\rho_{th} - \rho_{exp}}{\rho_{th}} \times 100$ %,

Where $\rho_{th} = \frac{1}{V_{\text{exp}}} \cdot n \cdot \frac{M_A}{N_A}$, Here, $V_{\text{exp}} = a^2 c$, n = number of atoms per unit cell, $M_A = \text{Atomic}$

weight of silicon nitride, N_A =Avogadro's number and $\rho_{exp} = \frac{M(mass)}{V(volume)}$

Porosity of different weight gain samples are shown in Table 2.

Table 2: Porosity and Density of Different Weight Gain RBSN Samples

Samples of RBSN	Experimental density ($\rho_{\rm exp}$)	Theoretical density (ρ _{th)}	Density	Porosity (%)
Reported Value for RBSN(fully nitrided) [4]			2.56	20-25 vol %
26% weight gain	1.998	2.835		29.54
42% weight gain	2.108	2.721		22.53
58.27% weight gain	2.181	2.776		21.45

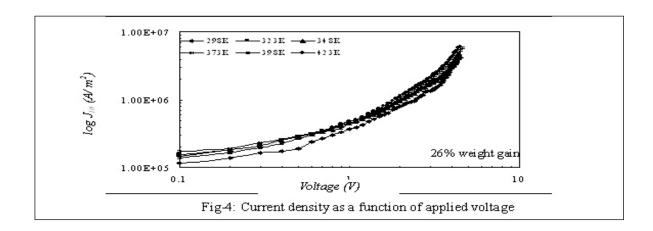
It is seen that porosity decreases with increasing weight gain.

3.3 Current Density

The variation of voltage of current density for 26% weight gain sample is shown in Fig 4. From this Fig, it is observed that current density increases with increasing voltage. The applied voltage is 0 to 5 V. The current density is weakly dependent on temperature.

Current density as function of applied voltage for 42% weight gain sample as show in Fig. 5(a). It is shown that current density increase with increasing voltage and is slightly increases with

temperature. There also the applied voltage is 0 to 5 V. The variation of current density as function voltage for 58.27% weight gain sample is shown in Fig. 5 (b). From this graph it is found that current density increases with increasing voltage and temperature. Current density at higher temperature (423K) is 10^1 orders higher than that of lower temperature (298K). Current density at different voltages follows the J \propto Vⁿ law.



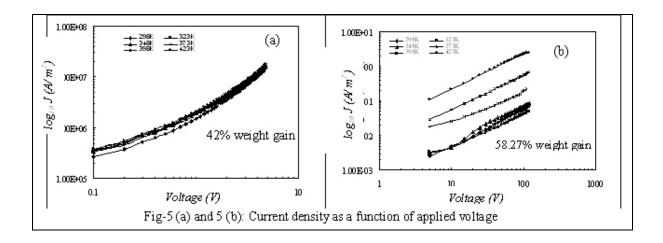
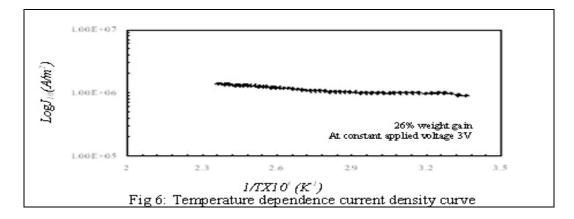


Table 3: The value of 'n' for Different RBSN Samples

Samples	n values	
26% weight gain	0-1.2V	1.3-5V
	0.79	1.69
42% weight gain	0.98	1.3
58.27% weight gain	0-120 V	
	0.99	



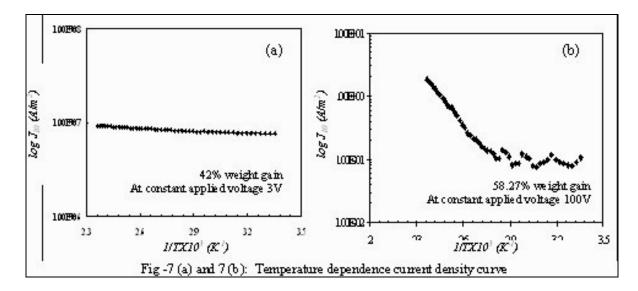
The value of n is close to unity. This means that the contact is ohmic. 'n' decreases with increasing weight gain. (Table 3).

3.4 Current Density – Temperature Characteristics

The applied voltage was kept at constant value of 100V for 58.27% weight gain sample and 3V for 42% and 26% weight gain samples. Current density as a function of temperature of 26%

weight gain sample is shown in Fig 6. From this Fig. 6, it is observed current density increases with increasing temperature. Value of activation energies (E) were calculated from the relation $J=J_{\rm o}$ exp (- E/kT). The activation energy of 26% weight gain sample is 0.078 eV.

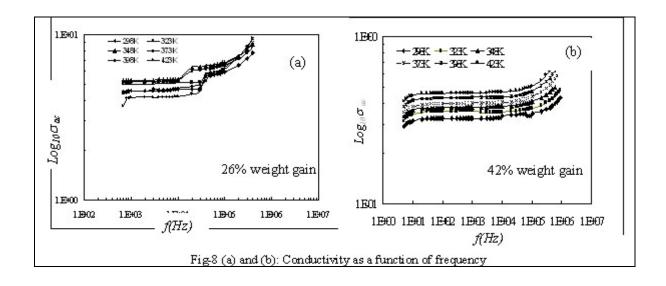
Current density vs. temperature curve for 42% weight gain ample as shown in Fig. 7 (a). It is found that current density increases with temperature. The activation



energy of this sample is 0.03 eV. and also weakly dependent on temperature. Log J vs. (1/Tx 10³) curve for 58.27% weight gain is shown in Fig. 7 (b). It is observed that current density increases with increasing temperature. At lower temperature, the current density weakly increases with increasing temperature. The activation energy in the higher temperature region is 0.83 eV and in the lower temperature region is 0.052 eV. The activation energy is related to the formation of carriers. At lower temperature the conduction may be due to conduction through defects states and at higher temperature the conduction may be due to electronic conduction.

3.5 A.C. Conductivity-Frequency Characteristics

A.C. conductivity (σ_{ac}) as a variation of frequency for 26% weight gain sample is shown in Fig. 8 (a). From this Fig. it is observed that σ_{ac} increases with increasing frequency and is weakly dependent on temperature. The values obtained over the frequency range 5Hz-13MHz. A.C. conductivity (σ_{ac}) vs. frequency curve for 42% weight gain sample is shown in Fig. 8 (b). It is found that a.c conductivity is almost independent of frequency. A.C. Conductivity is slightly increases with increasing temperature.



In the entire sample the σ_{ac} may be affected by frequency at high frequencies. From these experimental graphs it is also found that a.c. conductivity increases with decreasing weight gain. There is a large amount of uncreated free silicon owing to the inability of nitrogen to reach the remaining silicon as the reaction progresses. Reduction of the degree of nitridation caused progressive increase in a.c. conductivity. The low conductivity material follows $\sigma_{ac} \propto \omega^n$ where 0.7<n<1. These samples are weakly dependent on 'n'. For this reason the a.c. conductivity is independent on frequency.

4. Conclusions

X-ray diffraction (XRD) was recorded to calculate the lattice parametes and to see the effect of nitridation, on RBSN samples. The variation of current density with voltage and temperature was measured for d.c. measurement. The a.c. electrical properties such as a.c. conductivity, dielectric constant and dielectric loss factor as functions of frequency were investigated. The following conclusions are made from the present research work. From SEM micrographs of different weight gain samples, it is observed that the porosity decreases with increasing weight gain and the surface of the samples become smother. The current density -voltage characteristics of different weight gain RBSN samples is ohmic in nature. The current density of different weight gain RBSN samples is weakly dependent on temperature. A.C conductivity σ_{ac} is weakly dependent of frequency for higher weight gain A.C conductivity increases with decreases weight gain, less degrees of nitridation increases a.c. conductivity and is weakly dependent on temperature. The dielectric constant for higher degrees of nitridation samples is weakly dependent on frequency and is slightly increases by a step from 298k to 348k and becomes independent of temperature. The effects of both frequency and temperature variation are noticeably smaller on dielectric constant. This implies that the carriers make a relatively small contribution to ε' . Dielectric loss factor in the higher frequency range is independent of frequency Dielectric constant and loss factor increases progressively with reduction

of the degrees of nitridation. Less weight gain indicating that there is a large amount of uncreated free silicon.

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